FIG. 1

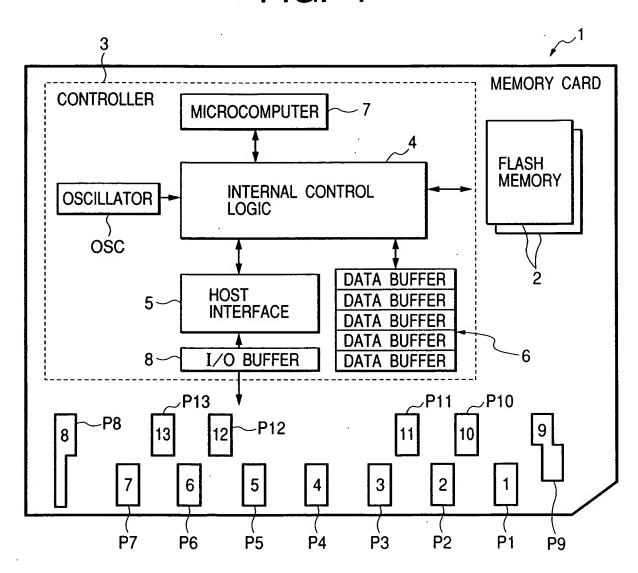
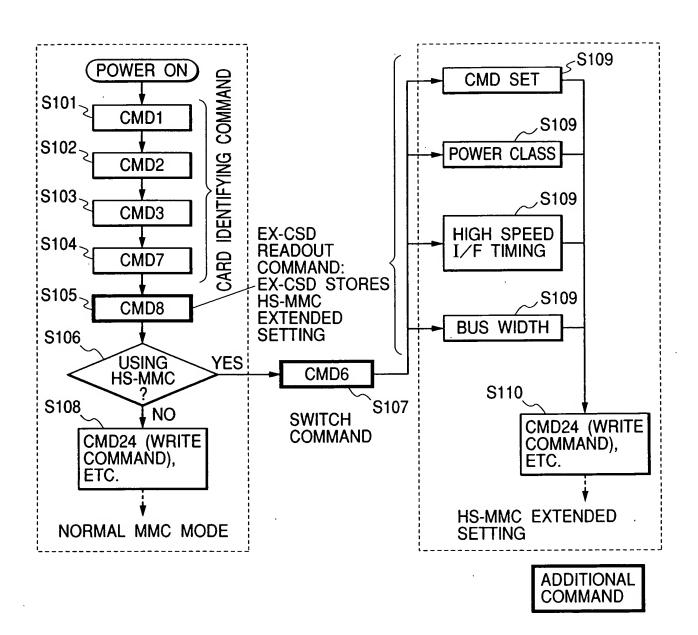


FIG. 2

PIN NO.	NAME OF PIN	I/0	CONTENTS
1	DAT3	I/O	DATA BUS BIT [3]
2	CMD	I/O	COMMAND
3	VSS1	-	GROUND
4	vcc	-	POWER SUPPLY
5	CLK	I	CLOCK
6	VSS2	-	GROUND
7	DAT0	I/0	DATA BUS BIT [0]
8	DAT1	I/0	DATA BUS BIT [1]
9	DAT2	I/0	DATA BUS BIT [2]
10	DAT4	I/0	DATA BUS BIT [4]
11	DAT5	I/0	DATA BUS BIT [5]
12	DAT6	I/O	DATA BUS BIT [6]
13	DAT7	I/0	DATA BUS BIT [7]

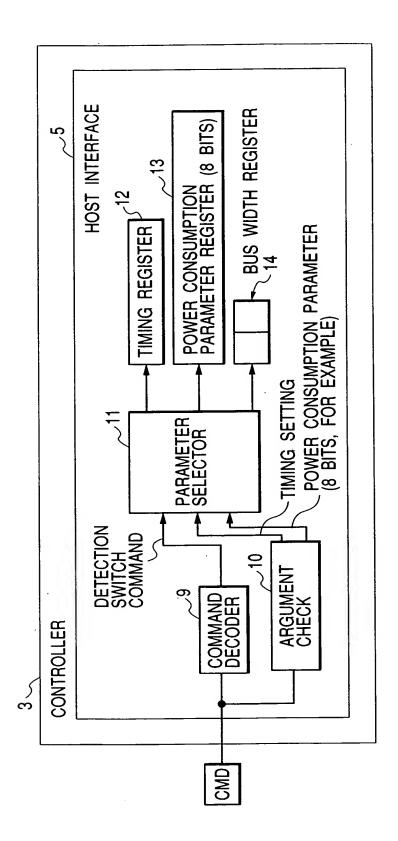
K

FIG. 3

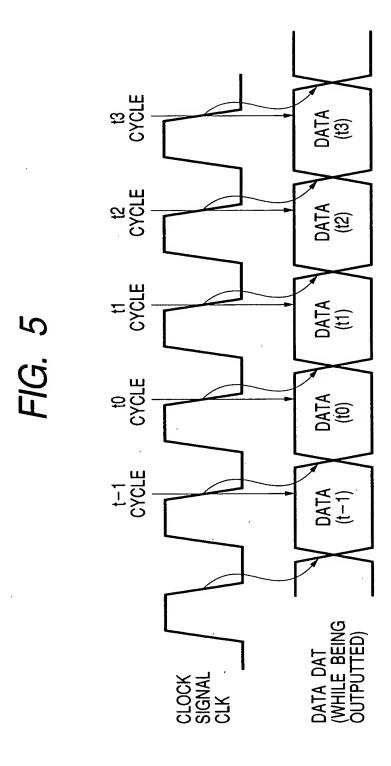




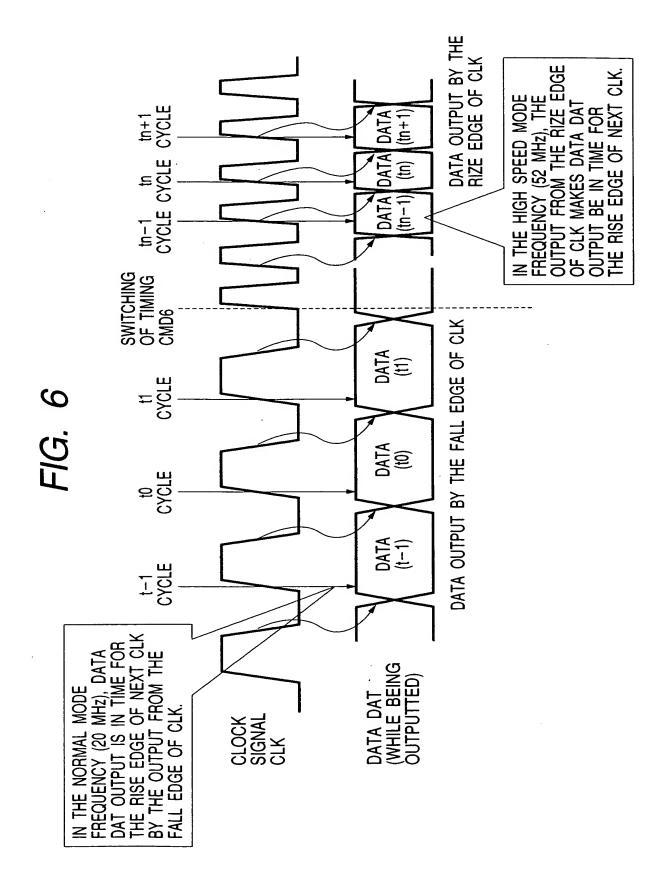
B



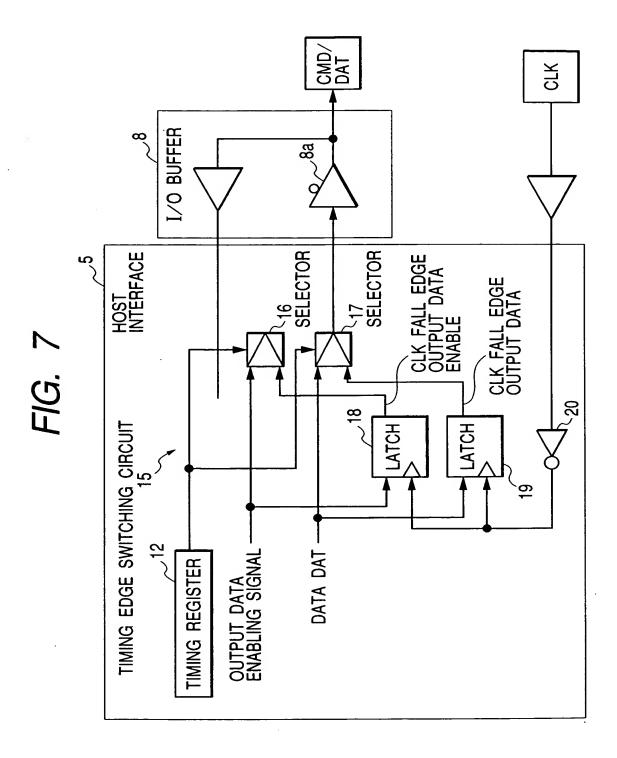
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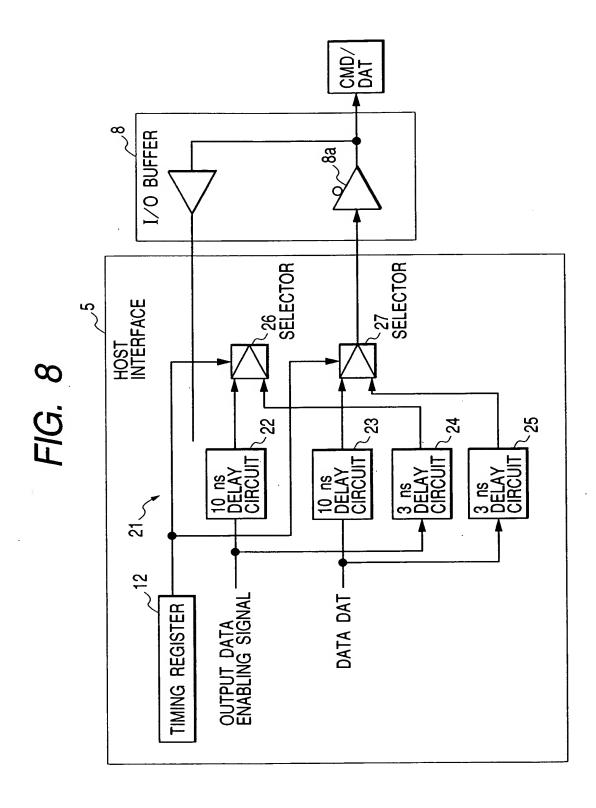


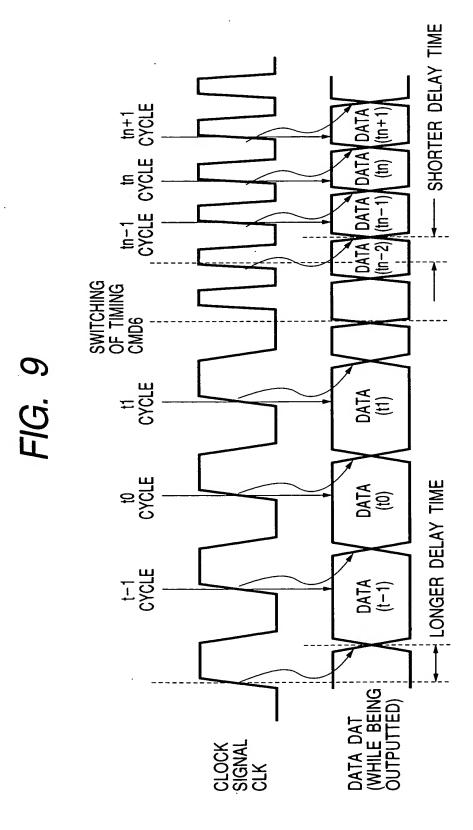
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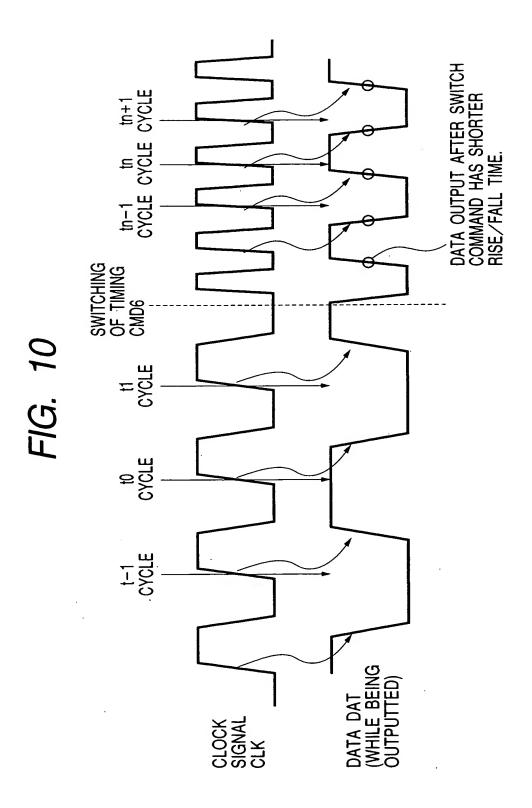


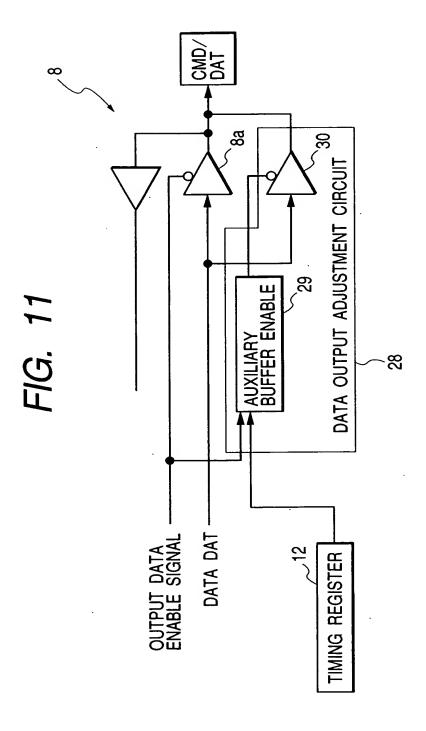
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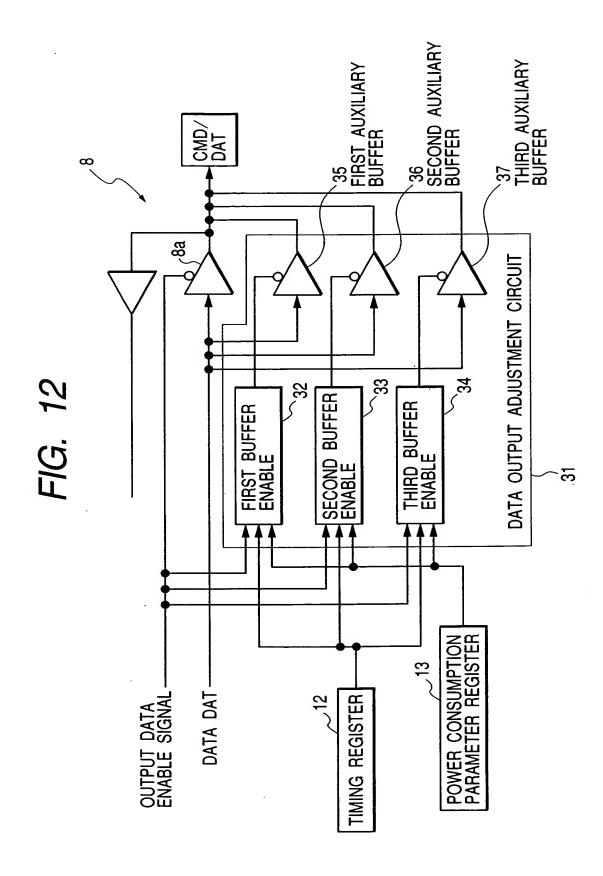


FIG. 13

TIMING REGISTER	POWER CONSUMPTION	FIRST AUXILIARY BUFFER	SECOND AUXILIARY THIRD AUXILIARY BUFFER	THIRD AUXILIARY BUFFER
0	DON'T CARE	0FF	OFF	JJ0
	•	NO	OFF	JH0
-	2	NO	NO	OFF
	3	NO	ON	NO

FIG. 14

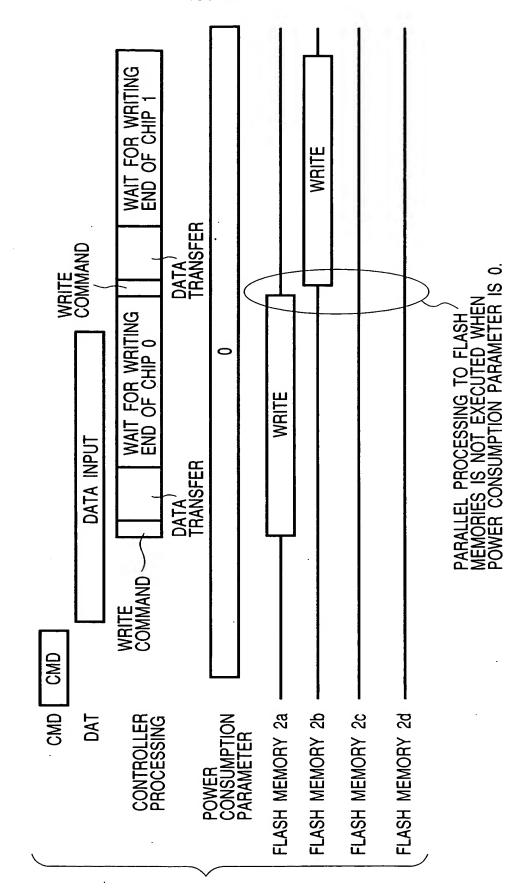
POWER CONSUMPTION PARAMETER REGISTER	SOURCE OSCILLATION FREQUENCY	SYSTEM CLOCK
0 (MAX 100mA)	20MHz	5MHz
1 (MAX 150mA)	20MHz	6.6MHz
2 (MAX 200mA)	20MHz	10MHz
3 (MAX 250mA)	20MHz	20MHz

FIG. 15 FREQUENCY SELECTION CIRCUIT 38 ر 39 ₂43 **OSCILLATOR** 1/2 FREQUENCY ______ **DIVIDER** SYSTEM CLOCK 1/3 FREQUENCY SELECTOR **DIVIDER** ²41 1/4 FREQUENCY _~13 **DIVIDER POWER** ²42 CONSUMPTION PARAMETER REGISTER

FIG. 16

POWER CONSUMPTION PARAMETER REGISTER	PARALLEL OPERATIONAL NUMBER OF FLASH MEMORY
0 (MAX 100mA)	1
1 (MAX 150mA)	2
2 (MAX 200mA)	3
3 (MAX 250mA)	4





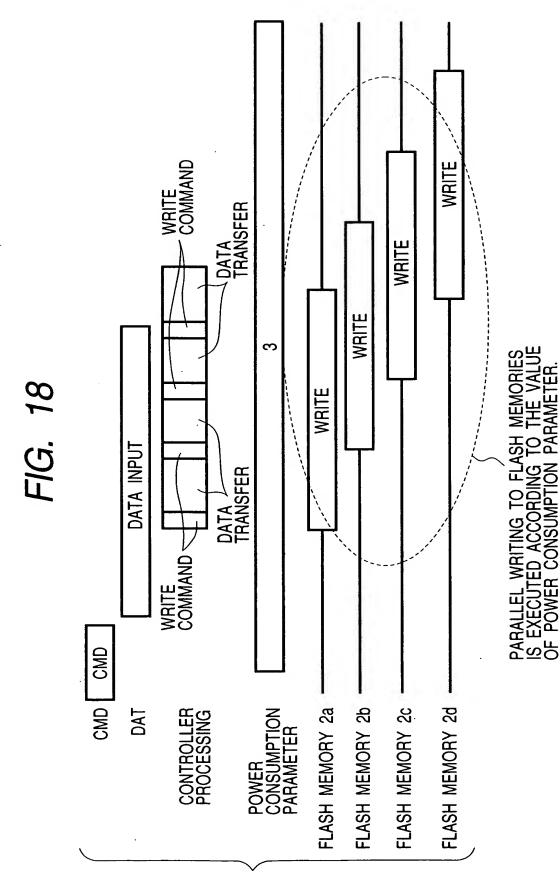


FIG. 19

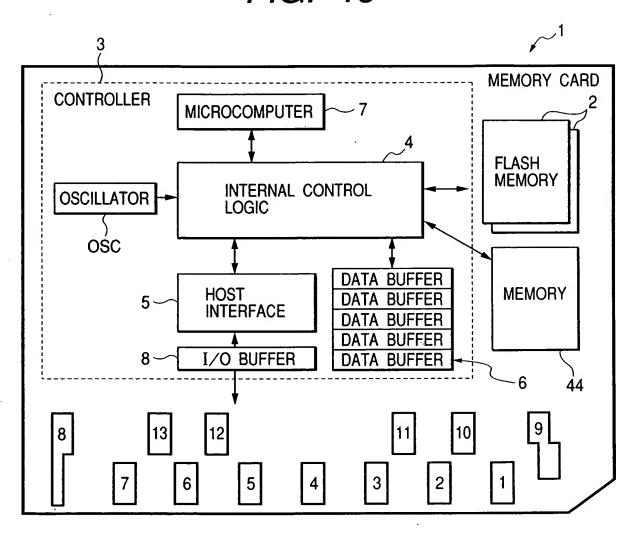
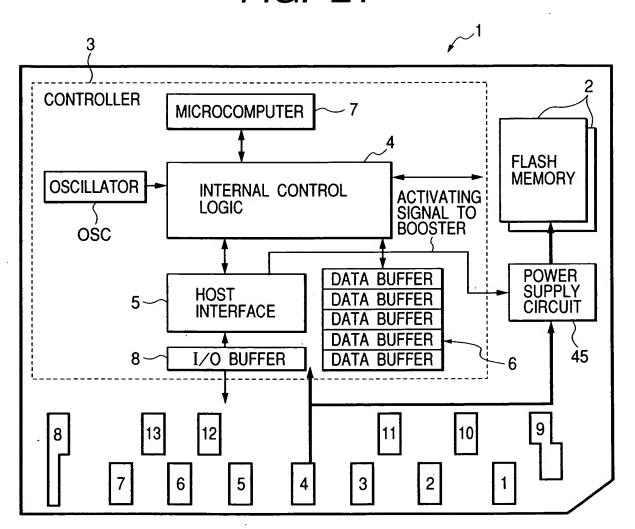


FIG. 20

POWER CONSUMPTION	TIMIL	TIMING REGISTER = 0	0 = }	IIMIT	TIMING REGISTER = 1	7 = 1
PARAMETER REGISTER	BUS WIDTH × 1	BUS BUS BUS BUS BUS BUS BUS BUS WIDTH \times 4 WIDTH \times 8 WIDTH \times 4 WIDTH \times 8	BUS WIDTH × 8	BUS WIDTH × 1	BUS WIDTH × 4	BUS WIDTH × 8
0 (MAX 100mA)	NON- ACTIVATED	NON- NON- ACTIVATED ACTIVATED ACTIVATED ACTIVATED ACTIVATED	NON- ACTIVATED	NON- ACTIVATED	NON- ACTIVATED	NON- ACTIVATED
1 (MAX 150mA)	NON- ACTIVATED	NON- NON- ACTIVATED ACTIVATED ACTIVATED ACTIVATED ACTIVATED	NON- ACTIVATED	NON- ACTIVATED	NON- ACTIVATED	ACTIVATED
2 (MAX 200mA)	NON- ACTIVATED	NON- ACTIVATED ACTIVATED ACTIVATED ACTIVATED ACTIVATED ACTIVATED	ACTIVATED	NON- ACTIVATED	ACTIVATED	ACTIVATED
3 (MAX 250mA)	NON- ACTIVATED	NON- ACTIVATED ACTIVATED ACTIVATED ACTIVATED ACTIVATED	ACTIVATED	ACTIVATED	ACTIVATED	ACTIVATED

FIG. 21



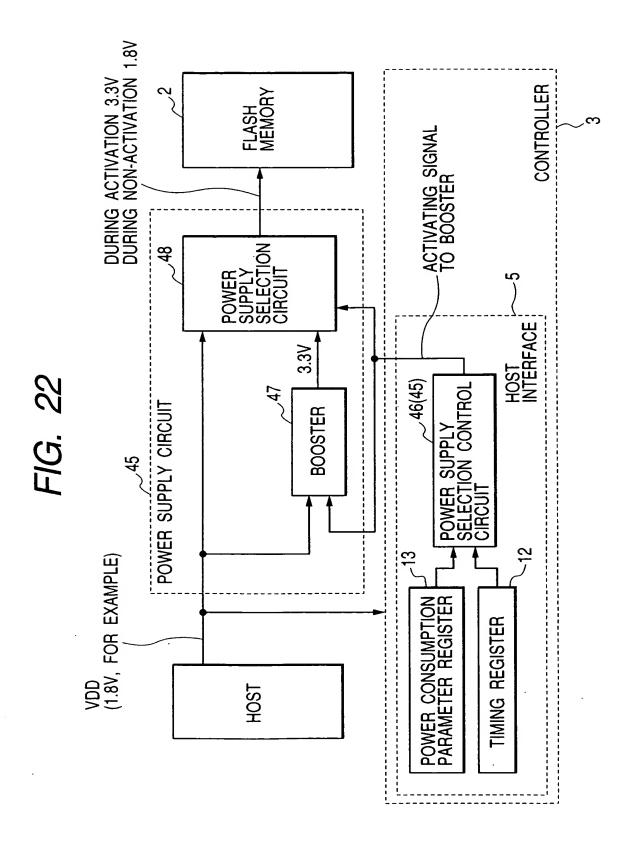
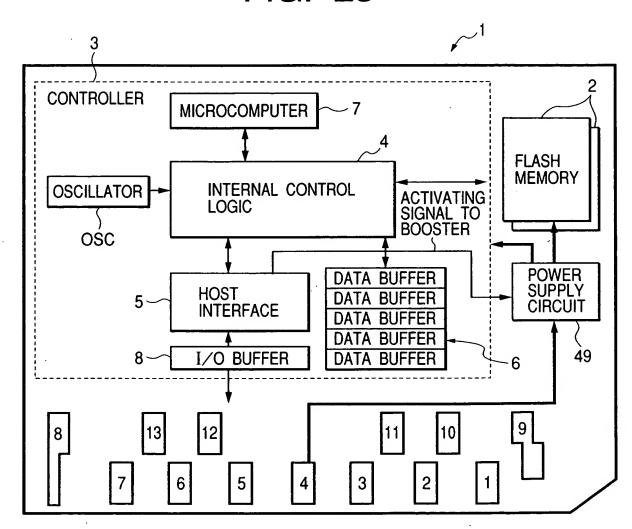


FIG. 23



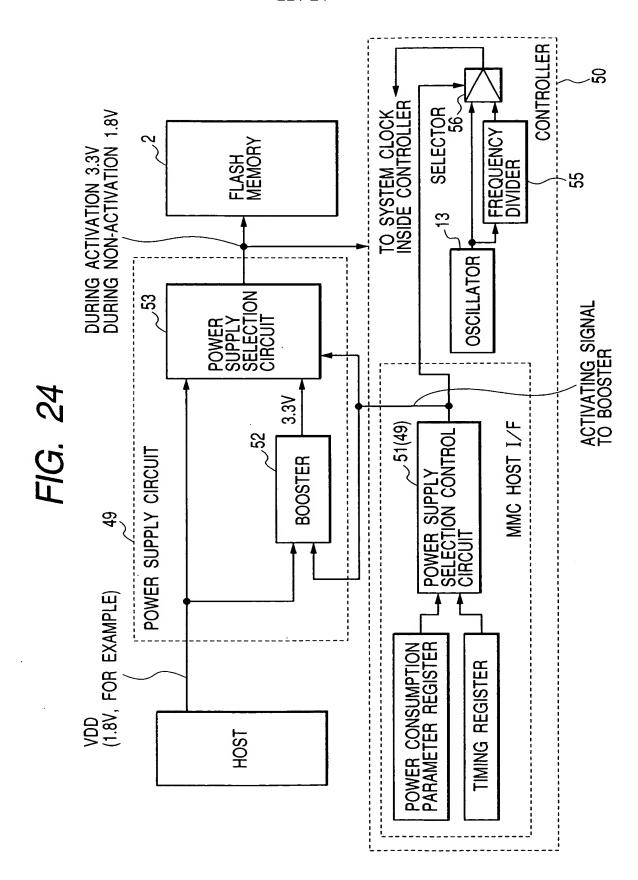


FIG. 25

STANDARD FOR DATA OUTPUT TIMING IN MMC

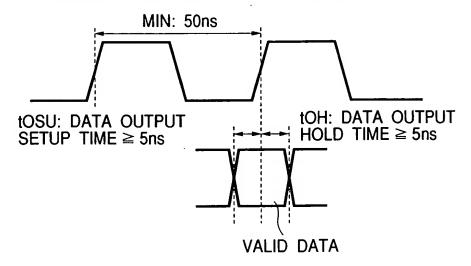


FIG. 26

STANDARD FOR DATA OUTPUT TIMING IN SD CARD

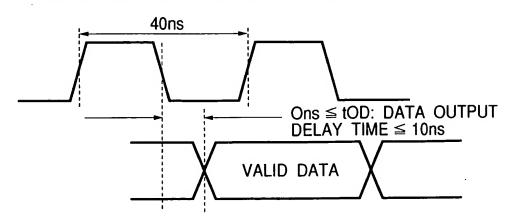
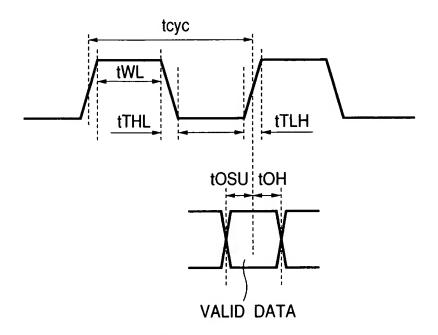


FIG. 27



tcyc: CYCLE TIME ≥ 19.2ns

tWL: CLOCK H OR L DURATION ≥ 6.5ns

tTHL: CLOCK FALL TIME \geq 3ns tTLH: CLOCK RIZE TIME \geq 3ns

tosu: data output setup time \geq 5ns toh: data output hold time \geq 5ns